

**• General Description**

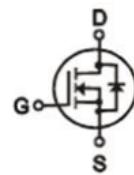
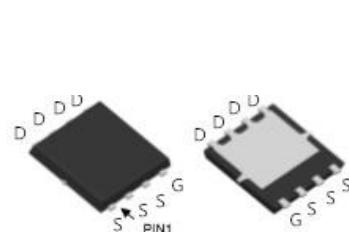
It combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

**• Features**

- Advance device construction
- Low  $R_{DS(ON)}$  to minimize conduction loss
- Low Gate Charge for fast switching
- Low Thermal resistance

**• Application**

- Synchronous Rectification for AC-DC/DC-DC converter
- Power Tools

**• Product Summary**

 $V_{DS} = 60V$ 
 $R_{DS(ON)} = 9m\Omega$ 
 $I_D = 60A$ 


DFN5 x 6

**• Ordering Information:**

|                           |           |
|---------------------------|-----------|
| Part NO.                  | CH013N06N |
| Marking                   | CH013N06N |
| Packing Information       | REEL TAPE |
| Basic ordering unit (pcs) | 5000      |

**• Absolute Maximum Ratings ( $T_C = 25^\circ C$ )**

| Parameter                                     | Symbol                    | Rating     | Unit       |
|---|---------------------------|------------|------------|
| Drain-Source Voltage                          | $V_{DS}$                  | 60         | V          |
| Gate-Source Voltage                           | $V_{GS}$                  | $\pm 20$   | V          |
| Continuous Drain Current                      | $I_D @ T_C = 25^\circ C$  | 60         | A          |
|   | $I_D @ T_C = 75^\circ C$  | 42         | A          |
|   | $I_D @ T_C = 100^\circ C$ | 31.5       | A          |
| Pulsed Drain Current <sup>①</sup>             | $I_{DM}$                  | 150        | A          |
| Total Power Dissipation( $T_C = 25^\circ C$ ) | $P_D @ T_C = 25^\circ C$  | 80         | W          |
| Total Power Dissipation( $T_A = 25^\circ C$ ) | $P_D @ T_A = 25^\circ C$  | 3.2        | W          |
| Operating Junction Temperature                | $T_J$                     | -55 to 150 | $^\circ C$ |
| Storage Temperature                           | $T_{STG}$                 | -55 to 150 | $^\circ C$ |
| Single Pulse Avalanche Energy@ $L=0.1mH$      | $E_{AS}$                  | 85         | mJ         |

**•Thermal resistance**

| Parameter                                    | Symbol            | Min. | Typ. | Max. | Unit  |
|--|-------------------|------|------|------|-------|
| Thermal resistance, junction - case          | R <sub>thJC</sub> | -    | -    | 1.5  | ° C/W |
| Thermal resistance, junction - ambient       | R <sub>thJA</sub> | -    | -    | 37   | ° C/W |
| Soldering temperature, wavesoldering for 10s | T <sub>sold</sub> | -    | -    | 265  | ° C   |

**•Electronic Characteristics**

| Parameter                         | Symbol              | Condition  | Min. | Typ | Max. | Unit |
|-----------------------------------|---------------------|--|------|-----|------|------|
| Drain-Source Breakdown Voltage    | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA               | 60   |     |      | V    |
| Gate Threshold Voltage            | V <sub>GS(TH)</sub> | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA | 1.2  |     | 2.5  | V    |
| Drain-Source Leakage Current      | I <sub>DSS</sub>    | V <sub>DS</sub> =60V, V <sub>GS</sub> =0V                |      |     | 1.0  | uA   |
| Gate- Source Leakage Current      | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V ,V <sub>DS</sub> =0V               |      |     | ±100 | nA   |
| Static Drain-source On Resistance | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =12A                |      | 9   | 13   | mΩ   |
|                                   |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A               |      | 14  | 19   | mΩ   |
| Forward Transconductance          | g <sub>FS</sub>     | V <sub>DS</sub> =25V, I <sub>D</sub> =10A                |      | 14  |      | s    |
| Source-drain voltage              | V <sub>SD</sub>     | I <sub>S</sub> =12A                                      |      |     | 1.21 | V    |

**•Electronic Characteristics**

| Parameter                    | Symbol           | Condition   | Min. | Typ | Max. | Unit |
|------------------------------|------------------|---|------|-----|------|------|
| Input capacitance            | C <sub>iss</sub> | V <sub>DS</sub> = 30V<br>V <sub>GS</sub> = 0V<br>f = 1MHz | -    | 930 | -    | pF   |
| Output capacitance           | C <sub>oss</sub> |   | -    | 230 | -    |      |
| Reverse transfer capacitance | C <sub>rss</sub> |   | -    | 8   | -    |      |

**•Gate Charge characteristics(T<sub>a</sub> = 25°C)**

| Parameter            | Symbol          | Condition   | Min. | Typ | Max. | Unit |
|----------------------|-----------------|---|------|-----|------|------|
| Total gate charge    | Q <sub>g</sub>  | V <sub>DD</sub> = 25V<br>I <sub>D</sub> = 8A<br>V <sub>GS</sub> = 10V | -    | 22  | -    | nC   |
| Gate - Source charge | Q <sub>gs</sub> |   | -    | 4.5 | -    |      |
| Gate - Drain charge  | Q <sub>gd</sub> |   | -    | 3.5 | -    |      |

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;

Fig.1 Gate-Charge Characteristics

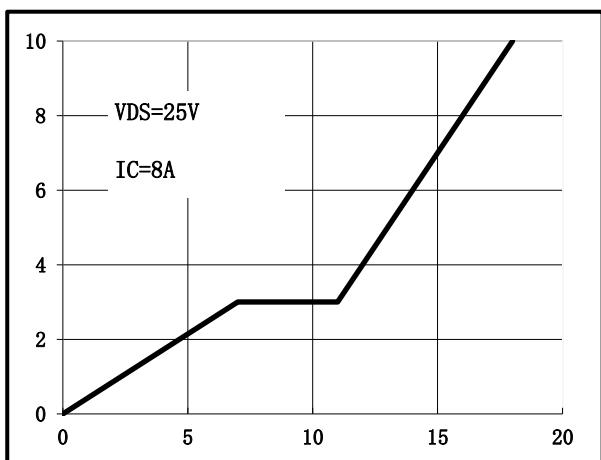


Fig.2 Capacitance Characteristics

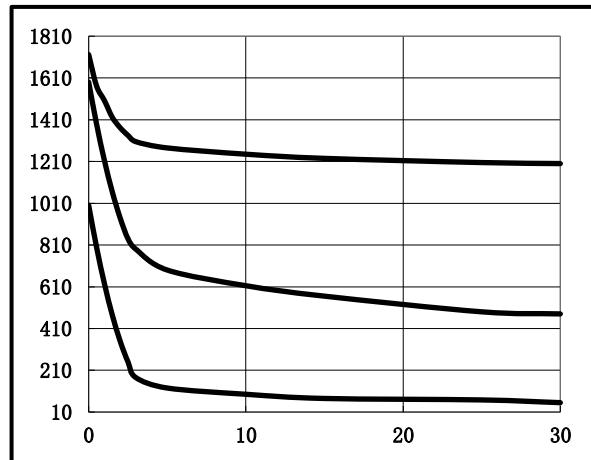


Fig.3 Power Dissipation

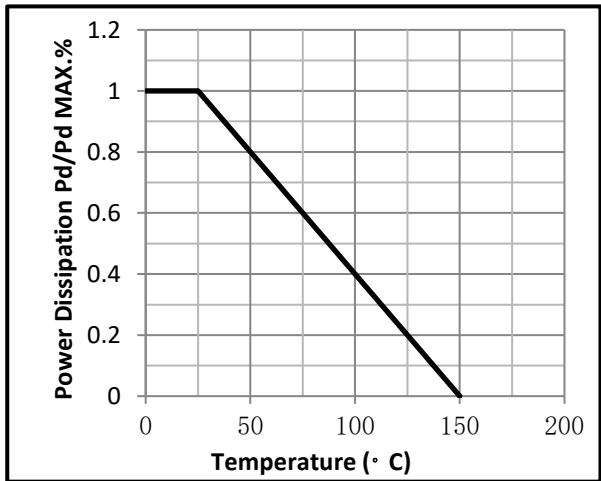


Fig.4 Typical output Characteristics

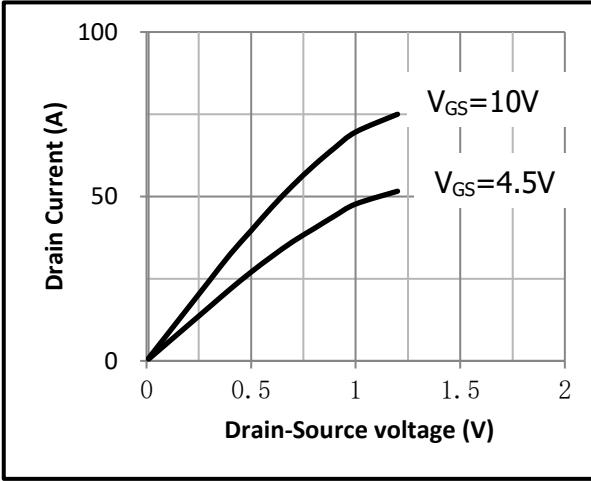


Fig.5 Threshold Voltage V.S Junction Temperature      Fig.6 Resistance V.S Drain Current

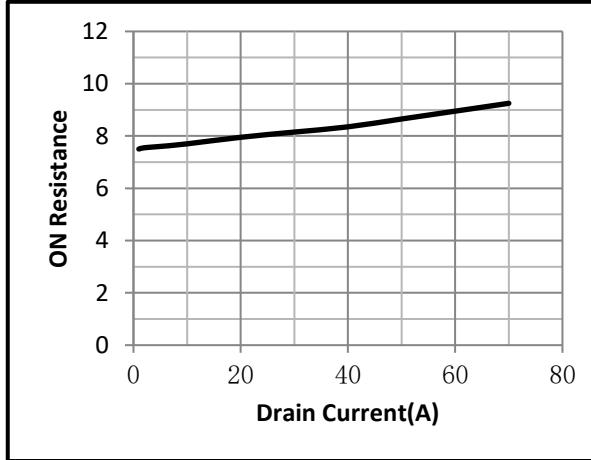
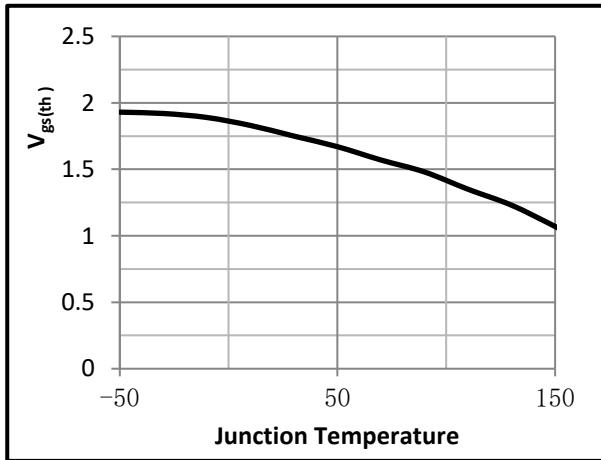


Fig.7 On-Resistance VS Gate Source Voltage

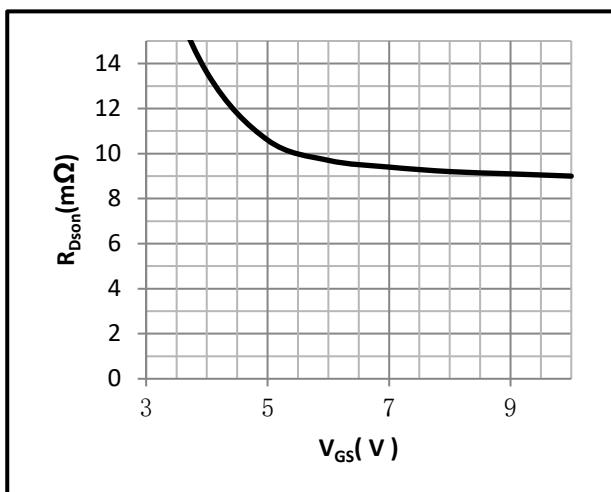


Fig.8 On-Resistance V.S Junction Temperature

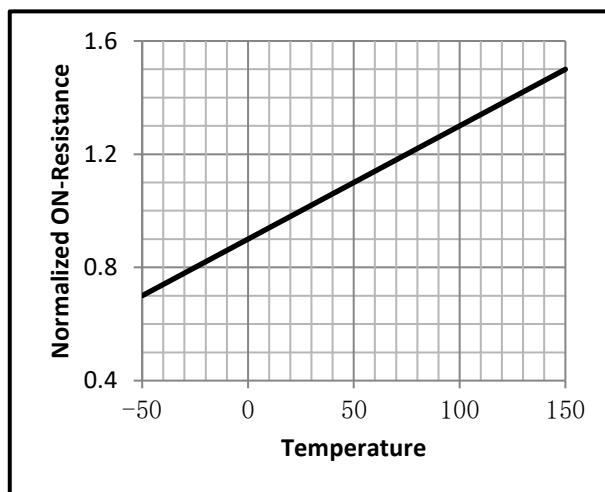


Fig.9 Switching Time Measurement Circuit

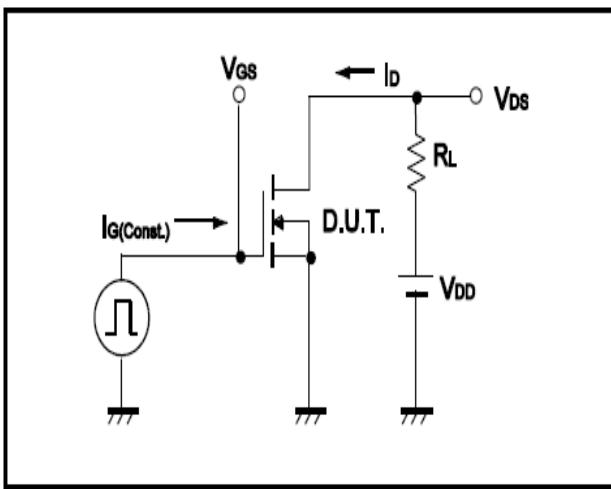


Fig.10 Gate Charge Waveform

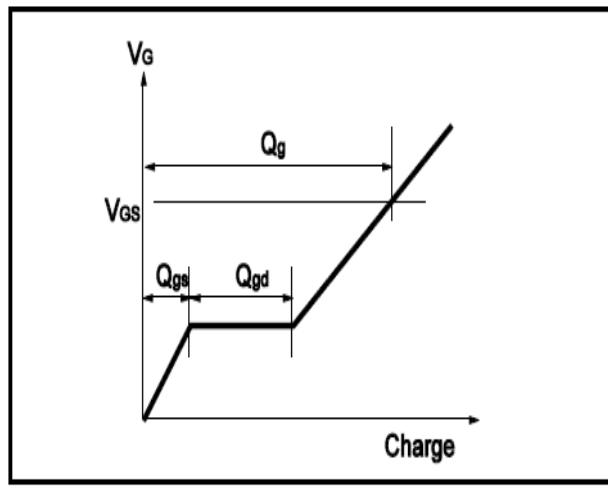


Fig.11 Switching Time Measurement Circuit

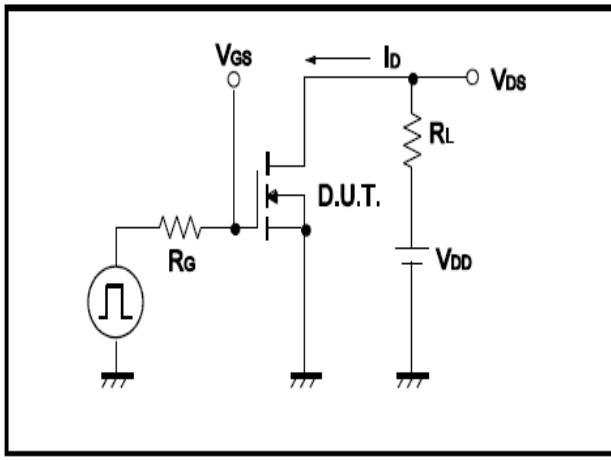
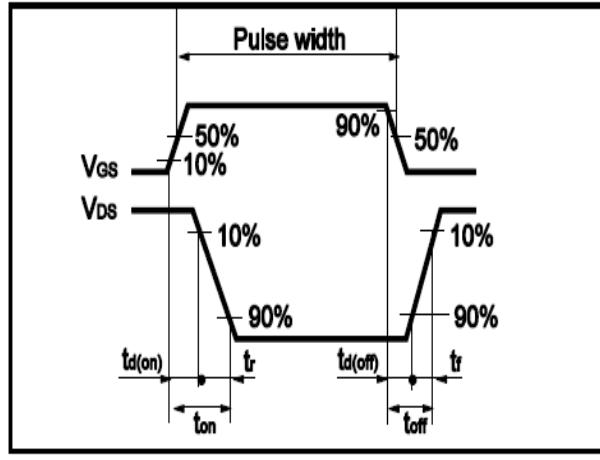
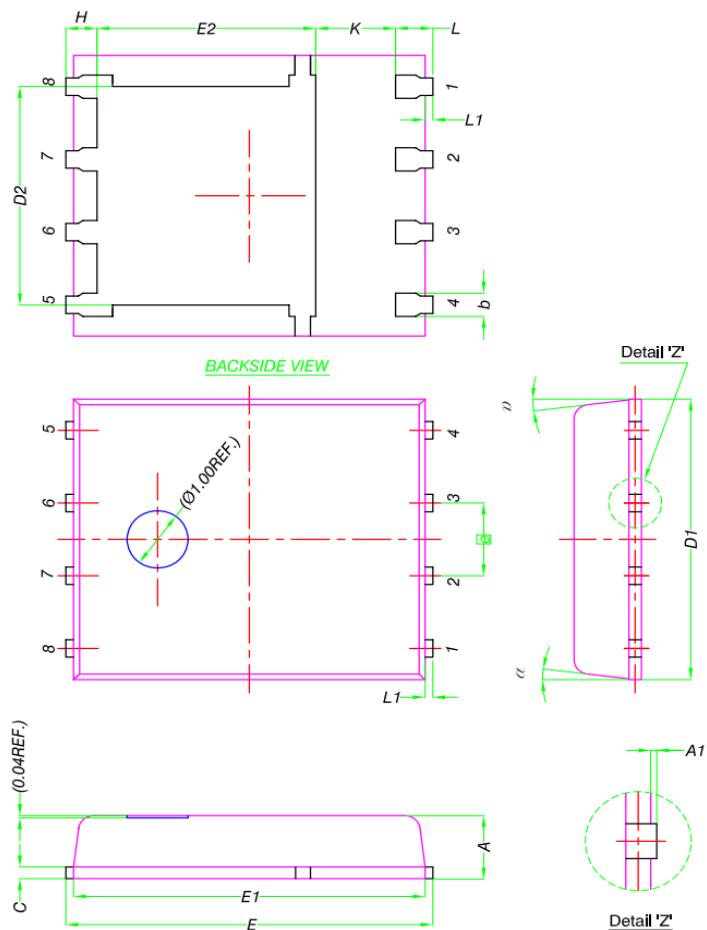


Fig.12 Gate Charge Waveform



**•Dimensions (DFN5x6)**

Unit: mm



| DIM.  | MILLIMETERS |      |      |
|-------|-------------|------|------|
|       | MIN.        | NOM. | MAX. |
| A     | 0.90        | 1.00 | 1.10 |
| A1    | 0           | -    | 0.05 |
| b     | 0.33        | 0.41 | 0.51 |
| C     | 0.20        | 0.25 | 0.30 |
| D1    | 4.80        | 4.90 | 5.00 |
| D2    | 3.61        | 3.81 | 3.96 |
| E     | 5.90        | 6.00 | 6.10 |
| E1    | 5.70        | 5.75 | 5.80 |
| E2    | 3.38        | 3.58 | 3.78 |
| e     | 1.27 BSC    |      |      |
| H     | 0.41        | 0.51 | 0.61 |
| K     | 1.10        | -    | -    |
| L     | 0.51        | 0.61 | 0.71 |
| L1    | 0.06        | 0.13 | 0.20 |
| alpha | 0°          | -    | 12°  |